

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Art Unit 1711

Brian Labrec

Confirmation No. 4087

Application No.: 10/677,092

Filed: September 30, 2003

For: INCREASING THERMAL CONDUCTIVITY  
OF HOST POLYMER USED WITH LASER  
ENGRAVING METHODS AND  
COMPOSITIONSVIA ELECTRONIC FILING

Examiner: S. McClendon

Date: February 8, 2007

**INFORMATION DISCLOSURE STATEMENT**

Applicants submit herewith information of which they are aware, and which they believe may be material to the examination of the application and in respect of which there may be a duty to disclose in accordance with 37 C.F.R. § 1.56. The information is listed on the attached Form PTO-1449.

The submission of information on the attached Form PTO-1449 is not intended as an admission that any such information constitutes prior art against the claims of the application under examination. Applicants do not waive any right to take any appropriate action to antedate or otherwise remove any information from the attached Form PTO-1449.

No fee is required since this document is being submitted after a Request for Continued Examination and prior to an Office Action.

If a fee is required, please charge to Deposit Account No. 50-2535 any fees that may be required for considering this Information Disclosure Statement under 37 C.F.R. § 1.17(p).

Respectfully submitted,

Date: February 8, 2007

DIGIMARC CORPORATION

CUSTOMER NUMBER 23735

Phone: 503-469-4800  
FAX 503-469-4777

By

  
Joel R. Meyer  
Registration No. 37,677

<b>INFORMATION DISCLOSURE STATEMENT</b>	Docket: P0889D	Ser. No.: 10/677,092
	Applicant: Brian Labrec	
	Filed: September 30, 2003	Group: 1711

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#### Foreign Patent Documents

### **Other References**

Ex'r Initial	Cite
	10/942,321, LaBrec, Office Action dated February 1, 2007.

**\*Examiner: Initial if considered, whether or not in conformance with MPEP 609; draw line through cite if not in conformance and not considered. Include copy of this form with next communication to applicant.**